DATA SHEET

NEC

PHOTOCOUPLER

PS2571-1,-4,PS2571L-1,-4

HIGH ISOLATION VOLTAGE SAFETY STANDARD TYPE MULTI PHOTOCOUPLER SERIES

–NEPOC Series–

DESCRIPTION

The PS2571-1, -4 and PS2571L-1, -4 are optically coupled isolators containing GaAs light emitting diodes and NPN silicon phototransistors.

The PS2571-1, -4 are in a plastic DIP (Dual In-line Package) and the PS2571L-1, -4 are lead bending type (Gull-wing) for surface mount.

FEATURES

- High isolation voltage (BV = 5 000 Vr.m.s.)
- High current transfer ratio (CTR = 200 % TYP.)
- High-speed switching (t_r = 3 μs TYP., t_f = 5 μs TYP.)
- Ordering number of taping product : PS2571L-1-E3, E4, F3, F4
- UL approved: File No. E72422 (S)
- BSI approved: No. 8343/8344
- CSA approved: No. CA 101391
- NEMKO approved: No. P98102650
- DEMKO approved: No. 308152
- SEMKO approved: No. 9832161/01
- FIMKO approved: No. F1 11899
- VDE0884 approved (Option)

APPLICATIONS

- Power supply
- Telephone, FAX
- FA/OA equipment
- Programmable logic controller

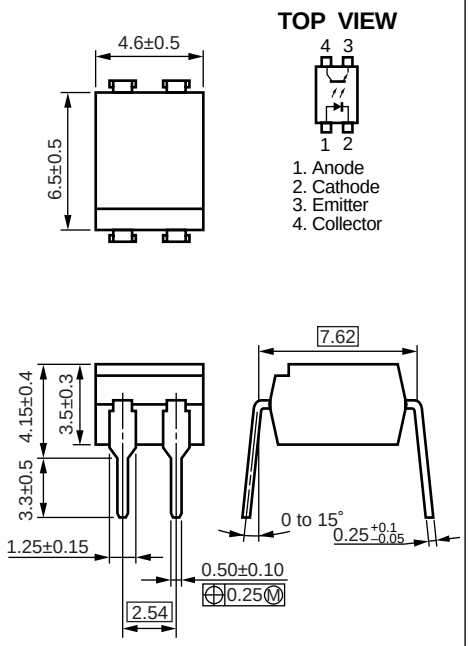
Document No. PN10238EJ01V0DS (1st edition)
(Previous No. P13857EJ2V0DS00)
Date Published February 2003 CP(K)
Printed in Japan

The mark ★ shows major revised points.

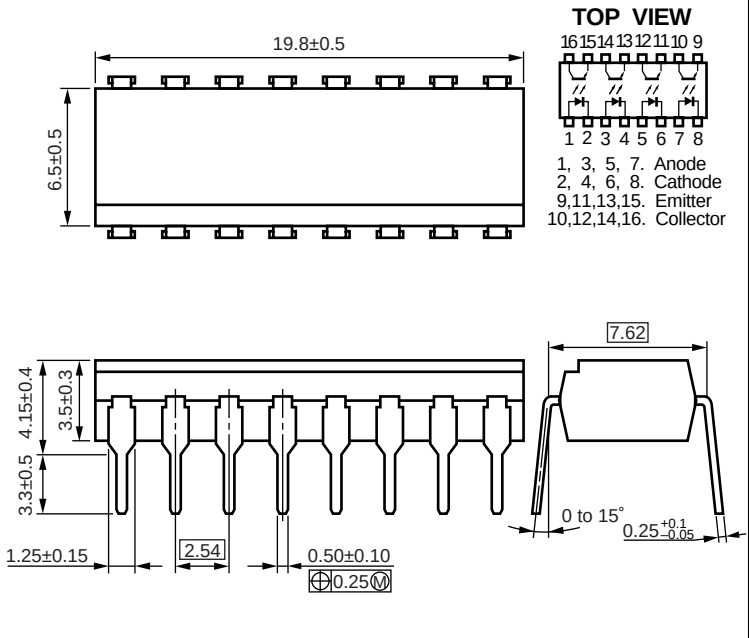
★ **PACKAGE DIMENSIONS (in millimeters)**

DIP type

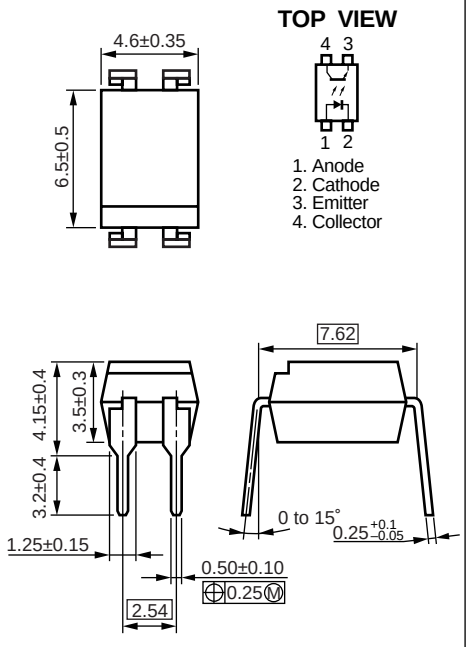
PS2571-1



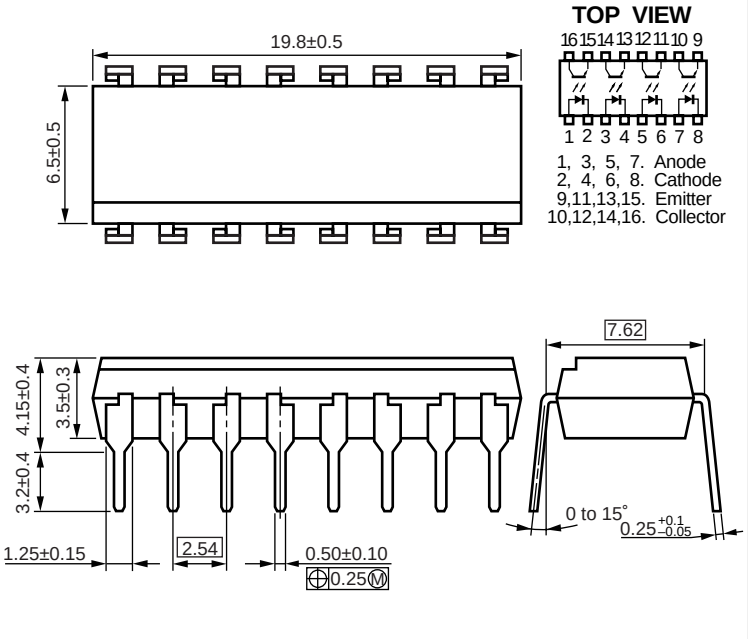
PS2571-4



PS2571-1

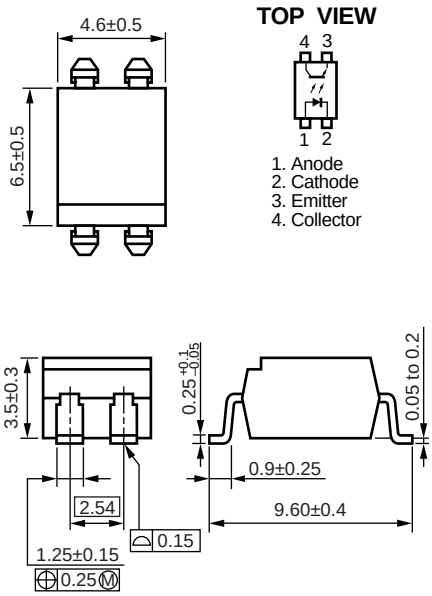


PS2571-4

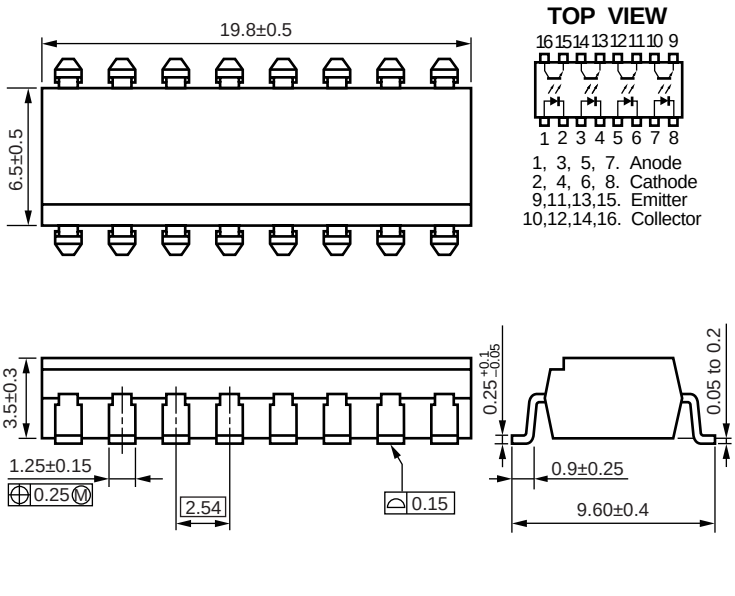


Lead bending type

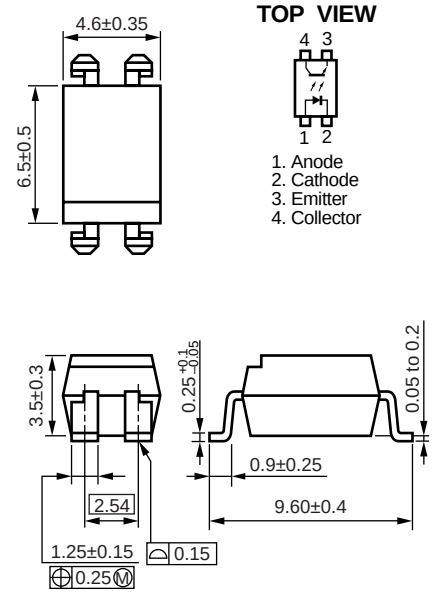
PS2571L-1



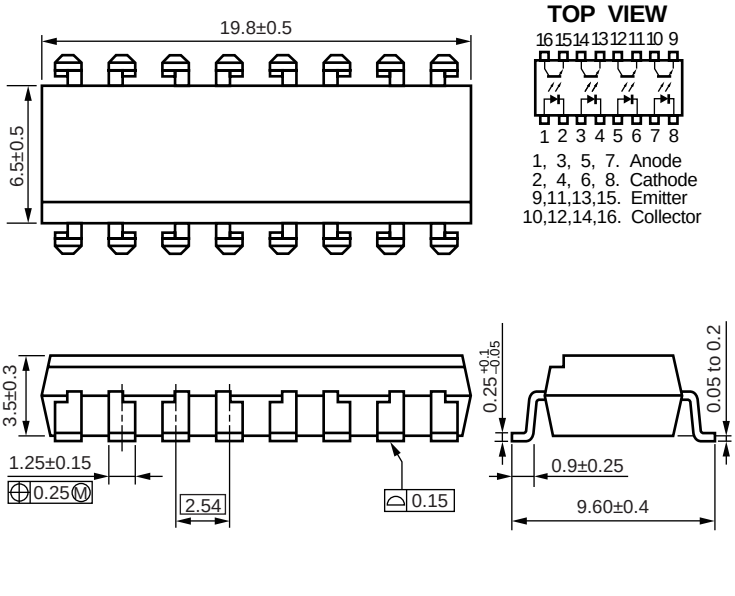
PS2571L-4



PS2571L-1

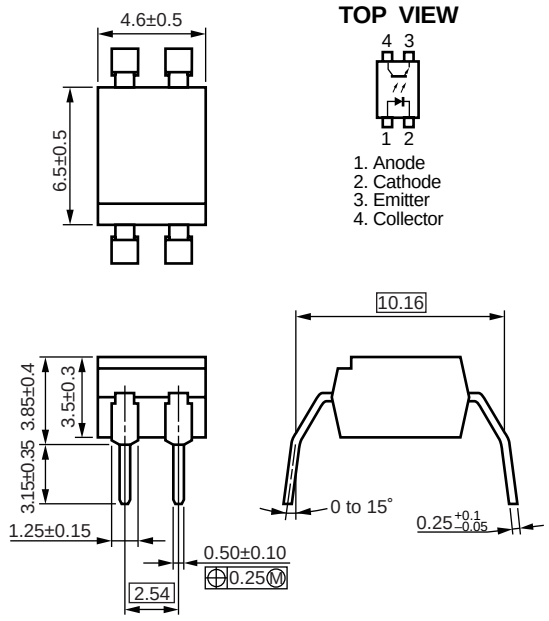


PS2571L-4

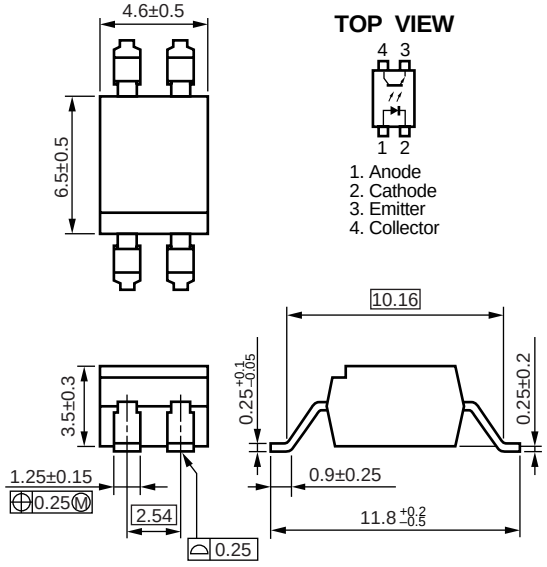


Lead bending type for long distance

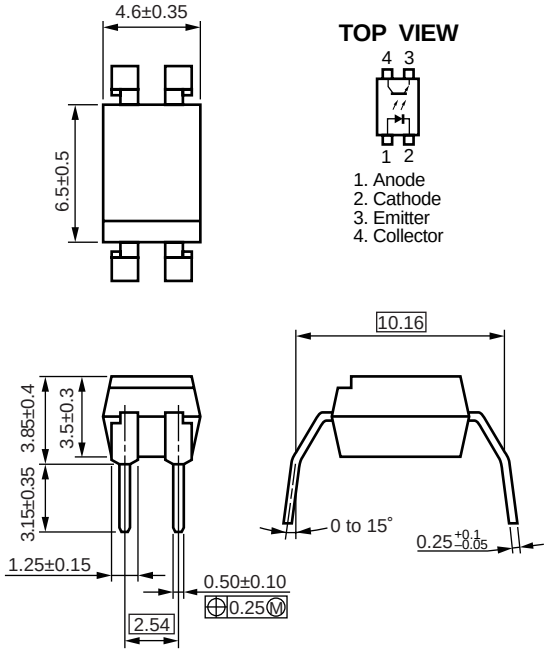
PS2571L1-1



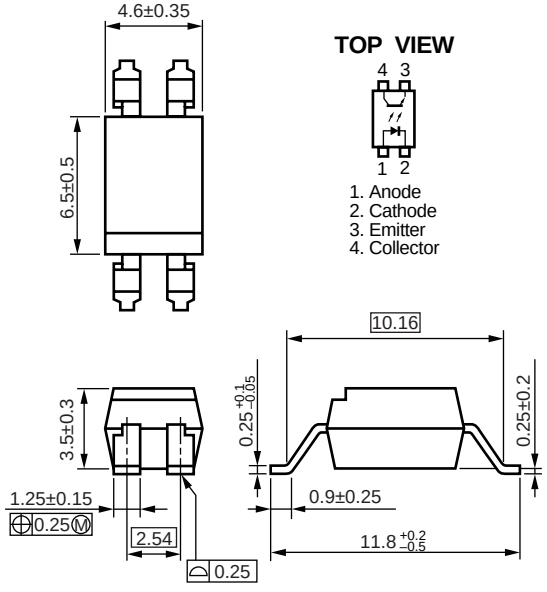
PS2571L2-1



PS2571L1-1



PS2571L2-1



PHOTOCOUPLER CONSTRUCTION

Parameter	Unit (MIN.)
Air Distance	7 mm
Outer Creepage Distance	7 mm
Inner Creepage Distance	4 mm
Isolation Distance	0.4 mm

ORDERING INFORMATION

Part Number	Package	Packing Style	Safety Standard Approval	Application Part Number *1
PS2571-1	4-pin DIP	Magazine case 100 pcs	Standard products (UL, CSA, BSI, NEMKO, SEMKO, DEMKO, FIMKO approved)	PS2571-1
PS2571L-1				
PS2571L-1-E3		Embossed Tape 1 000 pcs/reel		
PS2571L-1-E4				
PS2571L-1-F3		Embossed Tape 2 000 pcs/reel		
PS2571L-1-F4				
PS2571-4	16-pin DIP	Magazine case 20 pcs		PS2571-4
PS2571L-4				
PS2571-1-V	4-pin DIP	Magazine case 100 pcs	VDE0884 approved products (Option)	PS2571-1
PS2571L-1-V				
PS2571L-1-V-E3		Embossed Tape 1 000 pcs/reel		
PS2571L-1-V-E4				
PS2571L-1-V-F3		Embossed Tape 2 000 pcs/reel		
PS2571L-1-V-F4				
PS2571-4-V	16-pin DIP	Magazine case 20 pcs		PS2571-4
PS2571L-4-V				

***1** For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings		Unit
			PS2571-1, PS2571L-1	PS2571-4, PS2571L-4	
Diode	Forward Current (DC)	I_F	50		mA
	Reverse Voltage	V_R	6		V
	Power Dissipation Derating	ΔP_D/°C	0.7	0.55	mW/°C
	Power Dissipation	P_D	70	55	mW/ch
	Peak Forward Current *1	I_{FP}	1		A
Transistor	Collector to Emitter Voltage	V_{CEO}	40		V
	Emitter to Collector Voltage	V_{ECO}	5		V
	Collector Current	I_C	40		mA/ch
	Power Dissipation Derating	ΔP_C/°C	1.5	1.2	mW/°C
	Power Dissipation	P_C	150	120	mW/ch
Isolation Voltage *2		BV	5 000		Vr.m.s.
Operating Ambient Temperature		T_A	–55 to +100		°C
Storage Temperature		T_{stg}	–55 to +150		°C

***1** PW = 100 μs, Duty Cycle = 1 %

***2** AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output

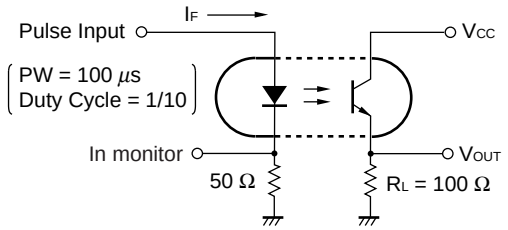
ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V_F	I_F = 10 mA		1.2	1.4	V
	Reverse Current	I_R	V_R = 5 V			5	μA
	Terminal Capacitance	C_t	V = 0 V, f = 1.0 MHz		50		pF
Transistor	Collector to Emitter Dark Current	I_{CEO}	V_{CE} = 40 V, I_F = 0 mA			100	nA
Coupled	Current Transfer Ratio (I_C/I_F) *1	CTR	I_F = 5 mA, V_{CE} = 5 V	80	200	400	%
	Collector Saturation Voltage	$V_{CE (sat)}$	I_F = 10 mA, I_C = 2 mA			0.3	V
	Isolation Resistance	R_{I-O}	V_{I-O} = 1.0 kV_{DC}	10^{11}			Ω
	Isolation Capacitance	C_{I-O}	V = 0 V, f = 1.0 MHz		0.5		pF
	Rise Time *2	t_r	V_{CC} = 10 V, I_C = 2 mA, R_L = 100 Ω		3		μs
	Fall Time *2	t_f			5		

***1** CTR rank (PS2571-1,PS2571L-1 only)

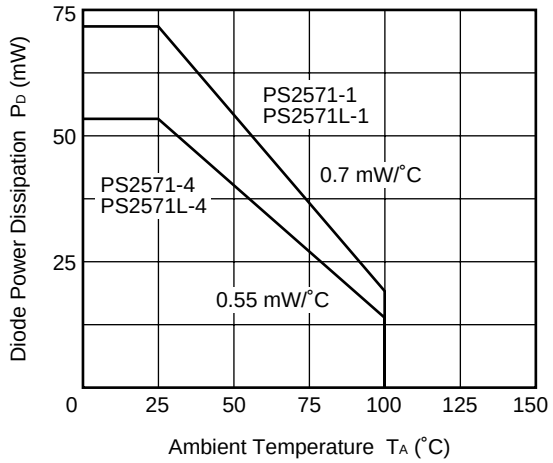
D : 100 to 300 %

***2** Test Circuit for Switching Time

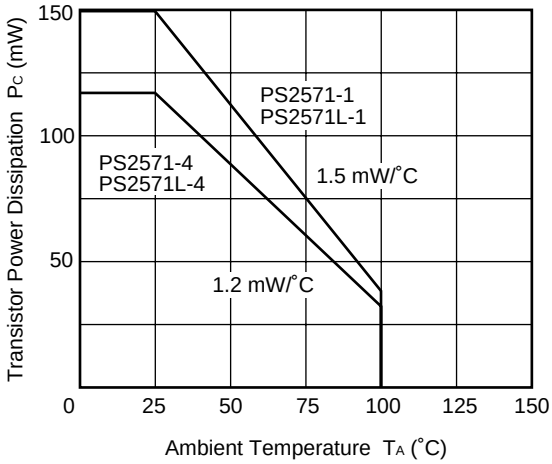


TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)

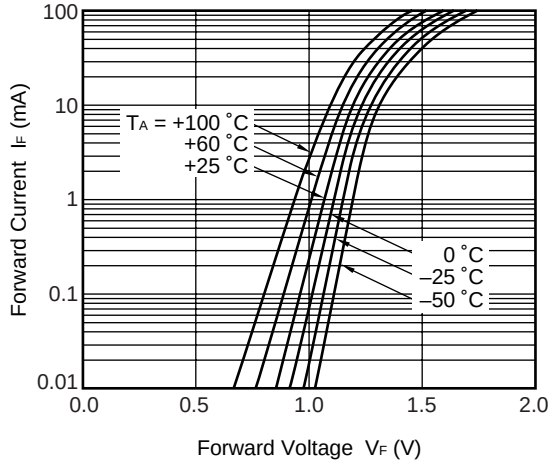
DIODE POWER DISSIPATION vs. AMBIENT TEMPERATURE



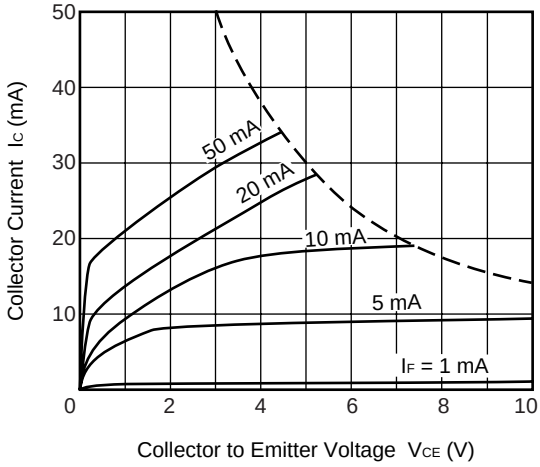
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



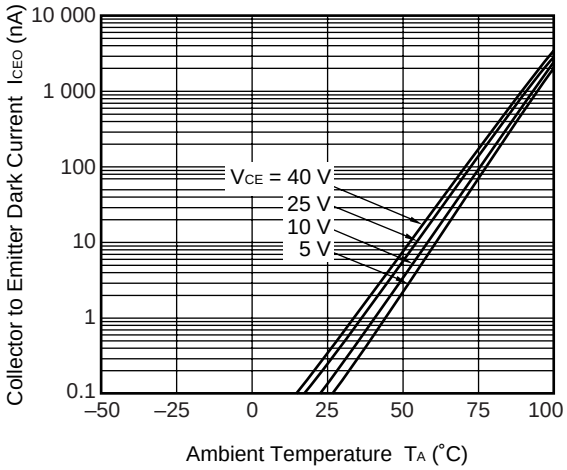
FORWARD CURRENT vs. FORWARD VOLTAGE



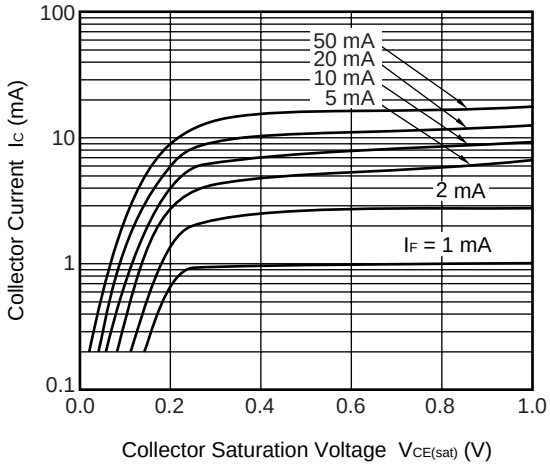
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



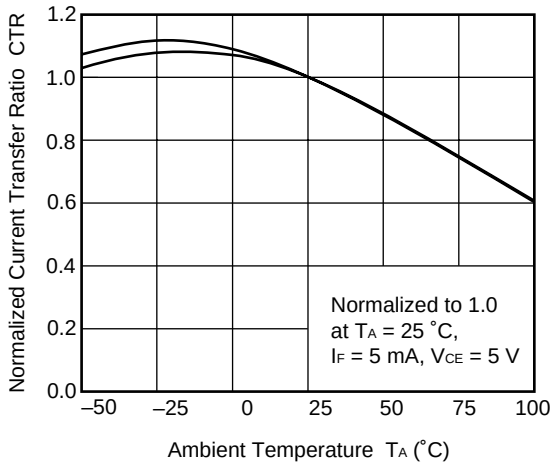
COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE



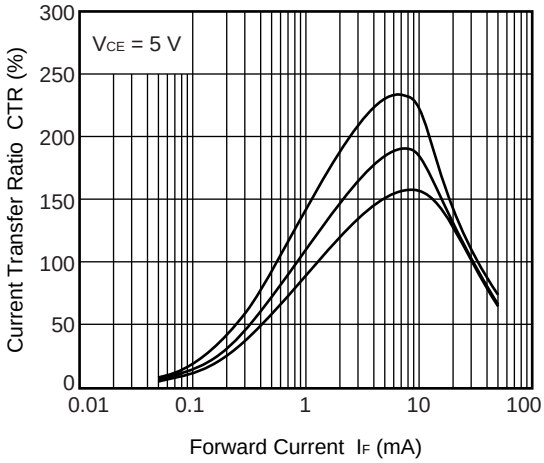
COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE



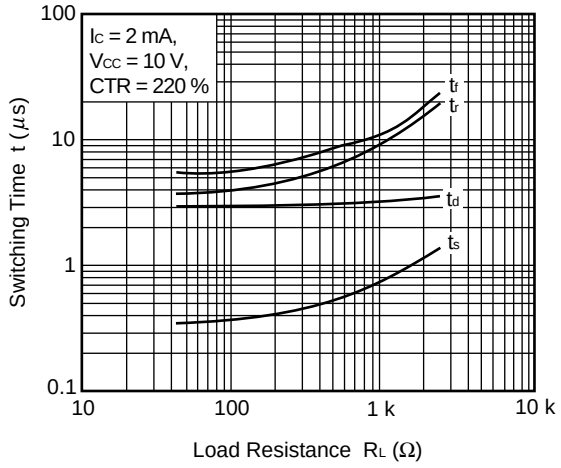
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



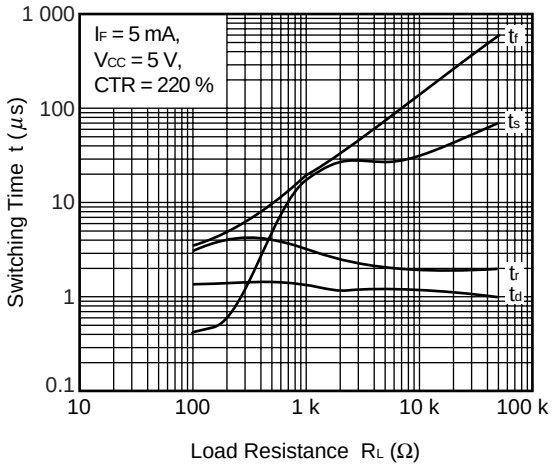
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



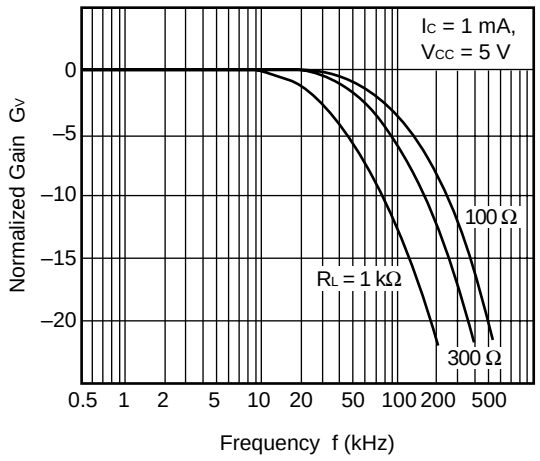
SWITCHING TIME vs. LOAD RESISTANCE



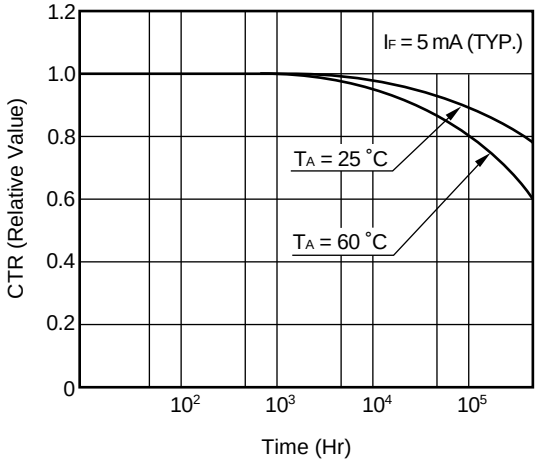
SWITCHING TIME vs. LOAD RESISTANCE



FREQUENCY RESPONSE



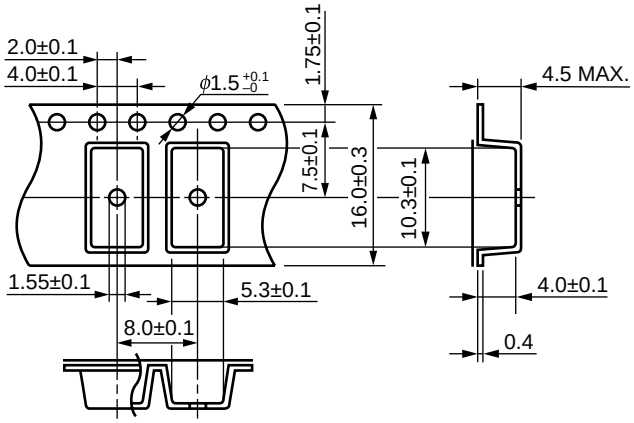
LONG TERM CTR DEGRADATION



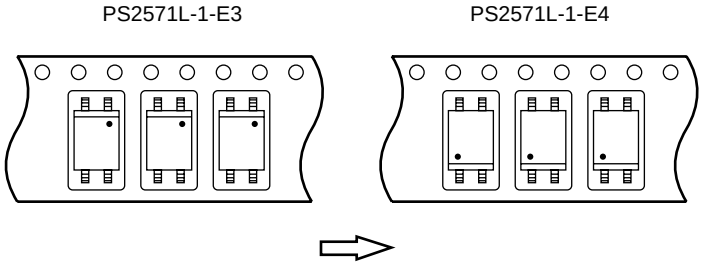
Remark The graphs indicate nominal characteristics.

★ **TAPING SPECIFICATIONS (in millimeters)**

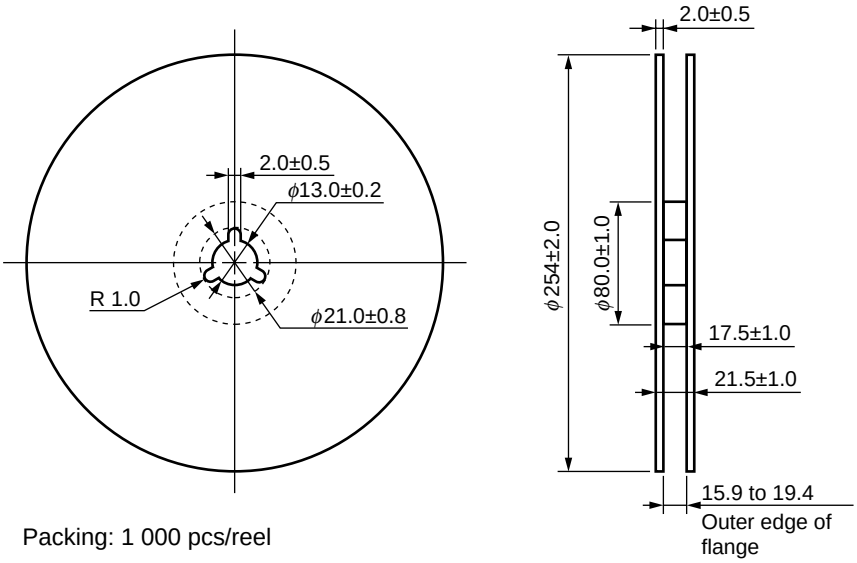
Outline and Dimensions (Tape)



Tape Direction

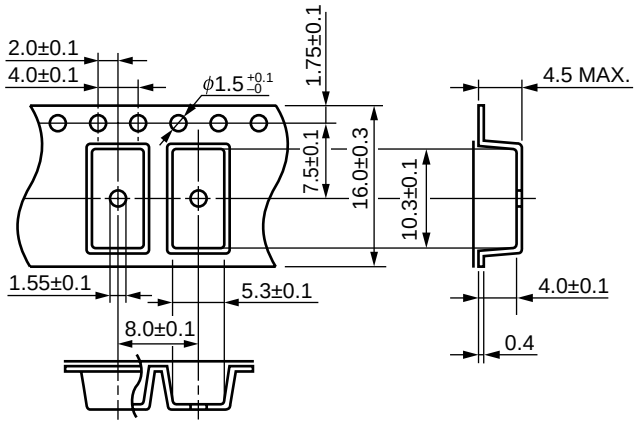


Outline and Dimensions (Reel)

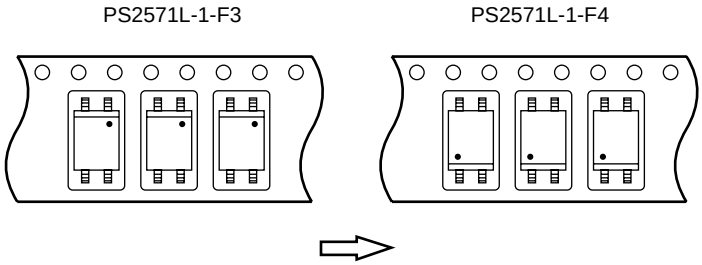


Packing: 1 000 pcs/reel

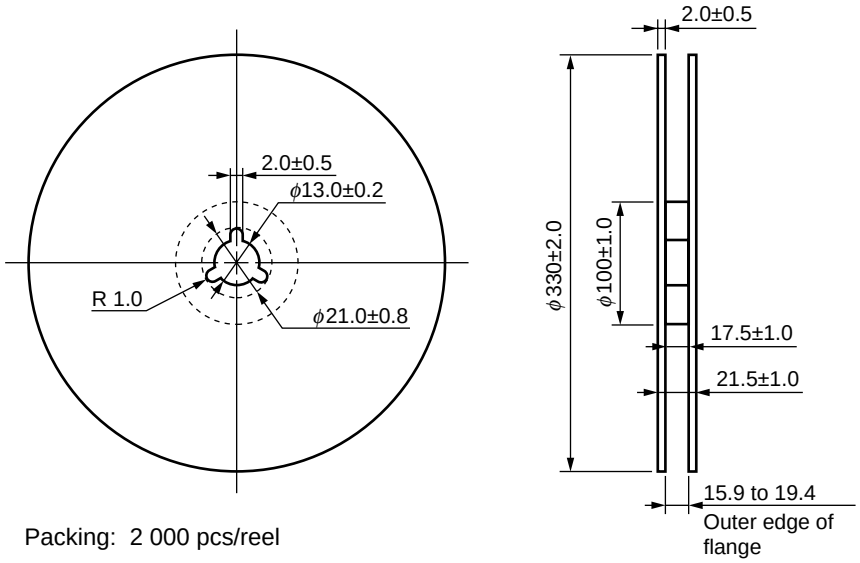
Outline and Dimensions (Tape)



Tape Direciton



Outline and Dimensions (Reel)



Packing: 2 000 pcs/reel

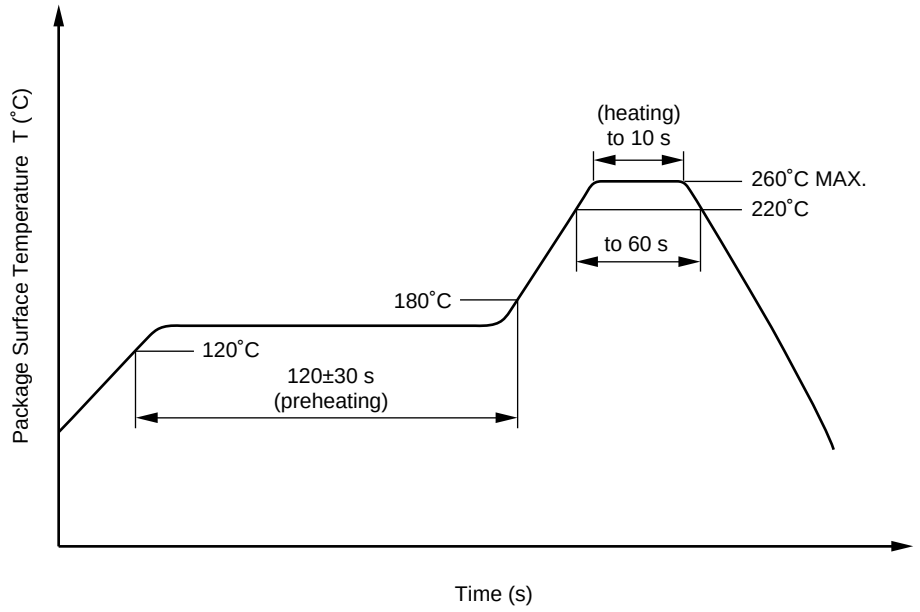
★ NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

• Peak reflow temperature	260°C or below (package surface temperature)
• Time of peak reflow temperature	10 seconds or less
• Time of temperature higher than 220°C	60 seconds or less
• Time to preheat temperature from 120 to 180°C	120±30 s
• Number of reflows	Three
• Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature	260°C or below (molten solder temperature)
• Time	10 seconds or less
• Preheating conditions	120°C or below (package surface temperature)
• Number of times	One (Allowed to be dipped in solder including plastic mold portion.)
• Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

★ **USAGE CAUTIONS**

1. Protect against static electricity when handling.

2. Avoid storage at a high temperature and high humidity.

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  (2) "NEC semiconductor products" means any semiconductor product developed or manufactured by or for NEC (as defined above).

M8E 00.4-0110

SAFETY INFORMATION ON THIS PRODUCT

Caution GaAs Products	The product contains gallium arsenide, GaAs. GaAs vapor and powder are hazardous to human health if inhaled or ingested. • Do not destroy or burn the product. • Do not cut or cleave off any part of the product. • Do not crush or chemically dissolve the product. • Do not put the product in the mouth. Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.

▶**For further information, please contact**

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